

3.5" Color TFT-LCD

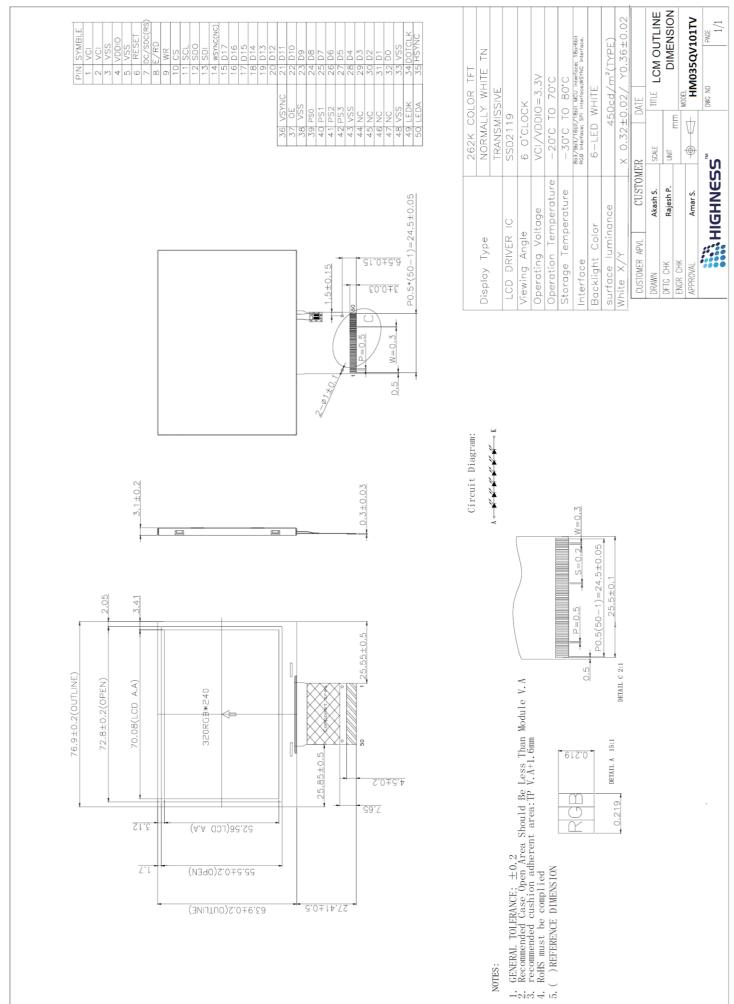
Release Date 14th Feb 2020

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1. General specification

ITEM	Standard value	UNIT		
LCD Type	TFT Transmissive			
Driver element	a-Si TFT Active matrix			
Number of Dots	320*(RGB)*240	Dots		
Pixel Arrangement	RGB Vertical Stripe			
Active Area	70.08 *52.56	mm		
Viewing Direction	6 O'clock			
Driver IC	SSD2119			
Module Size(W*H*T)	76.9x63.9x3.1	mm		
Approx. Weight	TBD	g		
Back Light	White LED			
System interface	1. 8/ 9/ 16/ 18-bit 6800-series / 8080-series Parallel Interface 2. Serial Peripheral Interface (SPI) 3. 18-/6-bit RGB interface (DE, DOTCLK, HSYNC, VSYNC, DB[17:0]) 4. WSYNC interface (system interface + WSYNC)			

3. Mechanical drawing



4. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	VDDIO	-0.3	4.0	V
Supply voltage for analog	VCI	-0.5	5.0	V
Supply current (One LED)	I_{LED}		30	mA
Operating temperature	T_{OP}	-20	+70	$^{\circ}$ C
Storage temperature	T_{ST}	-30	+80	°C

5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Min	Тур	Max	Unit	Applicable terminal
Supply voltage for logic	VDDIO	1.8	-	3.3	V	$V_{ m DD}$
Supply voltage for analog	VCI	2.5	3.3	3.6		
Lampt voltage	$V_{\rm IL}$	-0.3	-	0.2 V _{CC}	V	
Input voltage	V_{IH}	0.8 V _{CC}	-	V_{CC}	V	
Input leakage current	I_{LKG}	-	-	-	μΑ	
LED Forward voltage	V_{f}	3.0	3.2	3.4	V	With One LED
Input backlight current	I_{LED}	-	20	25	mA	With One LED

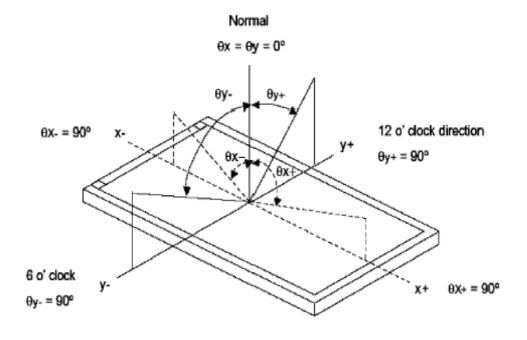
6.Backlight driving conditions

Item	Symbol	Symbol Values			Unit	Remark
nem	Symbol	Min.	Тур.	Max.	Oilit	Kemark
Voltage for LED backlight	$V_{\rm L}$	18	19.2	20.4	V	
Current for LED backlight	I_L	-	20	25	mA	
LED life time	-	20,000	-	-	Hr	

7. OPTICAL CHARACTERISTICS

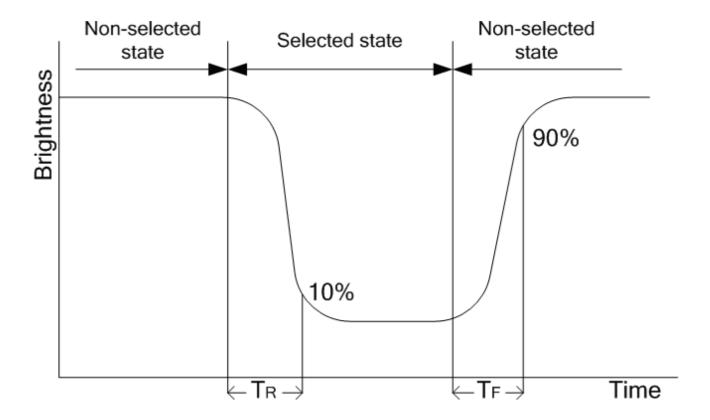
ITEM		SYMBOL	CONDITIONS	SPEC	CIFICAT	IONS	UNIT	NOTE
		SIMBOL	CONDITIONS	MIN.	TYP.	MAX	UNII	NOTE
Brightness		В		360	450	540	Cd/m ²	
Contrast Ratio	1	CR		320	400			
Response Tim	e	Tr+Tf			25	35	ms	
	Red	XR			0.633			
		YR	Viewing normal		0.329			
CIE	Green	XG	angle		0.297			
Color		YG			0.577			
coordinate	Blue	Хв			0.133			
Coordinate		YB			0.129			
	White	Xw			0.320			
		Yw			0.360			
	Hor.	$\theta_{\scriptscriptstyle X+}$		4±	60			
Viewing		$\theta_{\scriptscriptstyle X-}$	Center	4±	60		Dag	
Angle	Ver.	$ heta_{\scriptscriptstyle Y+}$	CR>=10	2 <u>+</u>	40		Deg.	
		$\theta_{\scriptscriptstyle Y-}$		4±	60			
Uniformity	Un			80	85		%	

Note 1 : Definition of Viewing Angle 9 x and 9 x:

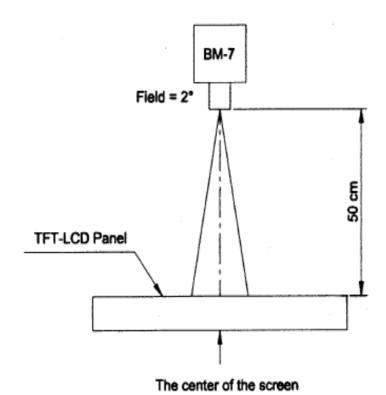


Note 2: Definition of contrast ratio CR:

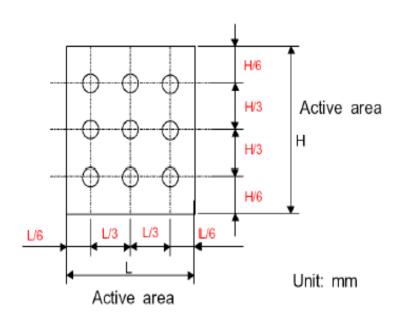
Note 3: Definition of response time (Tr, Tr)



The brightness test equipment setup 20mA Field=2° (As measuring "black" image, field=2° is the best testing condition)



Note 4:



8. MCU Interface Pin Function

. Table 2: Pin assignment

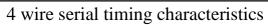
Pin No.	Crimbal	. Table 2: Pin assignment
	Symbol	Description Description
1~2	VCI VSS	Power supply for analog Ground.
3	VDDIO	Voltage input pin for logic I/O
5	VDDIO	Ground.
3	V 33	
6	RESB	System reset pin. - An active low pulse at this pin will reset the IC, Connect to VDDIO in normal operation
7	DC/SDC (RS)	A register select signal. Low: select an index or status register, High: select a control register.
8	E/RD	6800-system: E (enable signal) 8080-system: RD (read strobe signal) Serial mode: Not used and should be connected to VDDIO or Vss
9	WR	8080-system : WR (write strobe signal)
10	CS	CS : Chip select pin
11	SCL	Serial clock input
12	SDO	Data output pin in serial interface
13	SDI	Data input pin in serial interface
14	WSYNC	Ram Write Synchronization output -Leave it OPEN when not used
15~32	DB17~DB0	Data bus.
33	VSS	Ground.
34	DOTCLK	Dot-clock signal and oscillator source.
35	HSYNC	Line Synchronization input
36	VSYNC	Frame/Ram Write Synchronization input
37	OE	Display enable pin from controller.
38	VSS	Ground.
39	PS0	
40	PS1	Defen of Table 1
41	PS2	Refer of Table1
42	PS3	
43	VSS	Ground.
44~47	NC	Not Connection
48	VSS	Ground.
49	LEDK	Cathode of LED backlight.
50	LEDA	Anode of LED backlight.

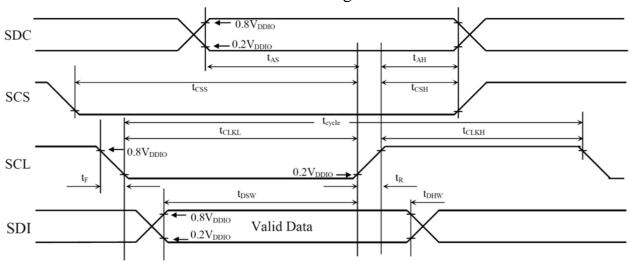
Table1

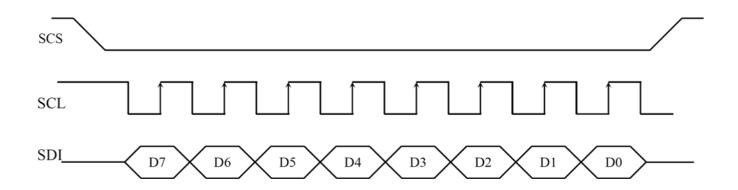
PS 3	PS2	PS1	PS0	Interface Mode
0	0	0	0	16-bit 6800 parallel interface (DB1-DB8&DB10-DB17)
0	0	0	1	8-bit 6800 parallel interface (DB10-DB17)
0	0	1	0	16-bit 8080 parallel interface (DB1-DB8&DB10-DB17)
0	0	1	1	8-bit 8080 parallel interface (DB10-DB17)
0	1	0	0	9-bit generic D[17:9] (262k colour) + 3-wire SPI If 65K color, D12 shorts to D17 internally
0	1	0	1	16-bit generic (262k colour)+ 3-wire SPI
0	1	1	0	18-bit generic (262k colour)+ 3-wire SPI
0	1	1	1	6-bit generic D[17:12] (262k colour) + 3-wire SPI
1	0	0	0	18-bits 6800 parallel interface (DB0-17)
1	0	0	1	9-bits 6800 parallel interface (DB9-17)
1	0	1	0	18-bit 8080 parallel interface(DB0-17)
1	0	1	1	9-bit 8080 parallel interface (DB9-17)
1	1	1	0	3-wire SPI
1	1	1	1	4-wire SPI

Timing characteristics Serial timing characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	77	-	-	ns
f _{CLK}	Serial Clock Cycle Time SPI Clock tolerance = +/- 2 ppm	1	-	15	MHz
t _{AS}	Register select Setup Time	4	-	-	ns
t _{AH}	Register select Hold Time	5	-	-	ns
tcss	Chip Select Setup Time	2	-	-	ns
t _{CSH}	Chip Select Hold Time	10	-	-	ns
t _{DSW}	Write Data Setup Time	5	-	-	ns
t _{OHW}	Write Data Hold Time	10	-	-	ns
t _{CLKL}	Clock Low Time	38	-	-	ns
t _{CLKH}	Clock High Time	38	-	-	ns
t _R	Rise time	-	-	4	ns
t _F	Fall time	-	-	4	ns





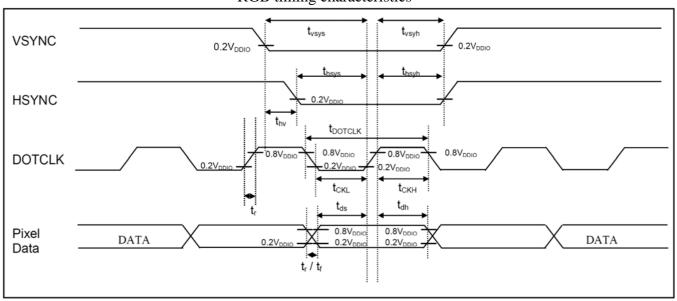


RGB timing characteristics

Symbol	Parameter	Min	Тур	Max	Unit
f _{DOTCLK}	DOTCLK Frequency (70Hz frame rate)	1	5.5	8.2	MHz
t _{DOTCLK}	DOTCLK Period	122	182	1000	ns
t _{VSYS}	Vertical Sync Setup Time	20	343	-	ns
t _{VSYH}	Vertical Sync Hold Time	20	(5 <u>2</u>)	-	ns
t _{HSYS}	Horizontal Sync Setup Time	20	-	-	ns
t _{HSYH}	Horizontal Sync Hold Time	20	721	_	ns
t _{HV}	Phase difference of Sync Signal Falling Edge	0	1929	320	tDOTCLK
tolk	DOTCLK Low Period	61	10	-	ns
tckH	DOTCLK High Period	61	7544	122	ns
t _{DS}	Data Setup Time	25	75429	-	ns
t _{DH}	Data hold Time	25	-	-	ns

Note: External clock source must be provided to DOTCLK pin of SSD2119. The driver will not operate in absence of the clocking signal.

RGB timing characteristics

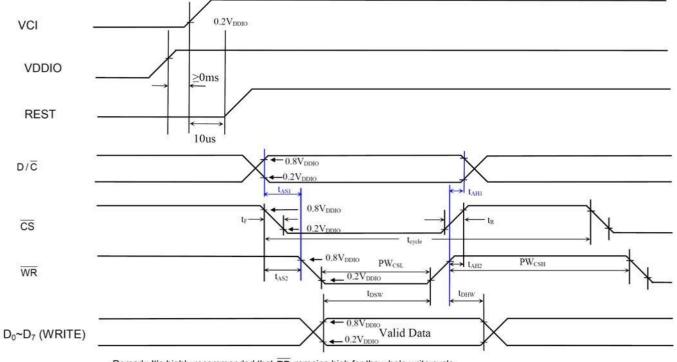


parallel 8080 MCU interface

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time (write cycle)	75		141	ns
t_{cycle}	Clock Cycle Time (read cycle) (Based on VOL/VOH = 0.3*VDDIO/0.7*VDDIO)	450		674	ns
t _{AS1}	Address Setup Time between (R/\overline{W}) and D/\overline{C}	0		,n a n	ns
t _{AH1}	Address Hold Time between (R/\overline{W}) and D/\overline{C}	0	7 2 1	8 2 0	ns
t _{AS2}	Address Setup Time between (R/W) and CS	0	-	-	ns
t _{AH2}	Address Hold Time between (R/W) and CS	0		-	ns
t _{DSW}	Data Setup Time (D0~D7, WRITE)	5	-		ns
t _{DHW}	Data Hold Time (D0~D7, WRITE))	5	-		ns
tacc	Data Access Time (D0~D7, READ)	250		-	ns
tон	Output Hold time (D0~D7, READ)	100	-	-	ns
PWcsl	Pulse width /CS low (write cycle)	40	-	-	ns
PWcsh	Pulse width /CS high (write cycle)	25	-	-	ns
PW _{CSL}	Pulse width /CS low (read cycle)	500	Tell .	1620	ns
PW _{CSH}	Pulse width /CS high (read cycle)	500	5 S	813	ns
t _R	Rise time	4	-	4	ns
t _F	Fall time			4	ns

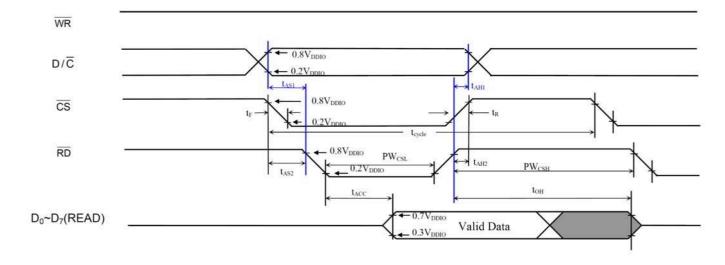
parallel 8080 MCU interface timing characteristics

Write Cycle



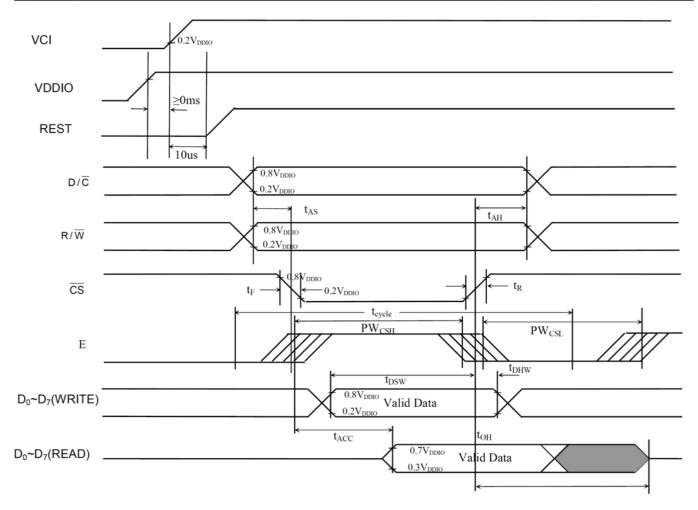
Remark: It's highly recommended that $\overline{\text{RD}}\,$ remains high for the whole write cycle

Read Cycle

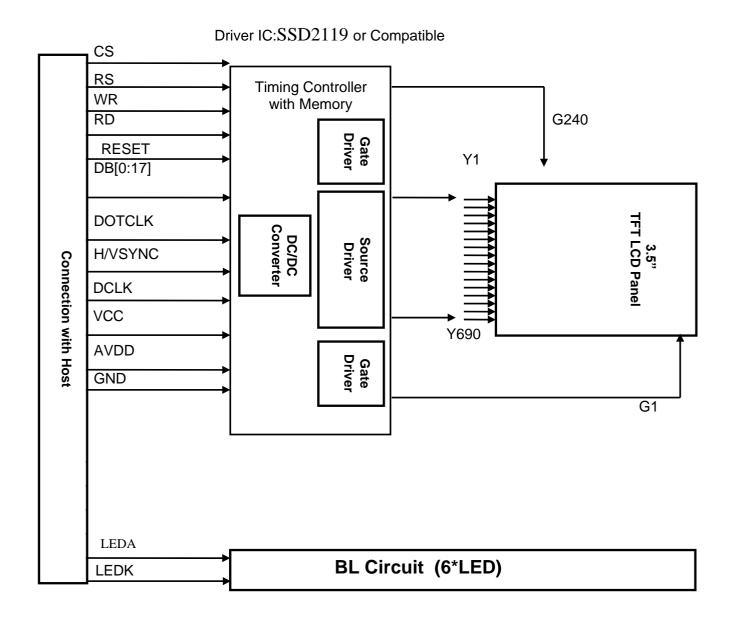


8.3.4 parallel 6800 interface

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time (write cycle)	75			ns
t _{cycle}	Clock Cycle Time (read cycle) (Based on VOL/VOH = 0.3*VDDIO/0.7*VDDIO)	450	-	u u	ns
t _{AS}	Address Setup Time (R/W)	0	-	-	ns
t _{AH}	Address Hold Time (R/W)	0	-	-	ns
t _{DSW}	Data Setup Time (D0~D7, WRITE)	5	-	-	ns
t _{DHW}	Data Hold Time (D0~D7, WRITE))	5	-	-	ns
t _{ACC}	Data Access Time (D0~D7, READ)	250	-	<u>=</u>	ns
t _{OH}	Output Hold time (D0~D7, READ)	100	-	-	ns
PWcsL	Pulse width /CS low (write cycle)	40	-	2	ns
PW _{CSH}	Pulse width /CS high (write cycle)	25	-	2	ns
PW _{CSL}	Pulse width /CS low (read cycle)	500	-	2	ns
PW _{CSH}	Pulse width /CS high (read cycle)	500	-	-	ns
t _R	Rise time		-	4	ns
t _F	Fall time	i ii	*	4	ns



9. BLOCK DIAGRAM



10. LCM Quality Criteria

VISUAL & FUNCTION INSPECTION STANDARD

Inspection conditions

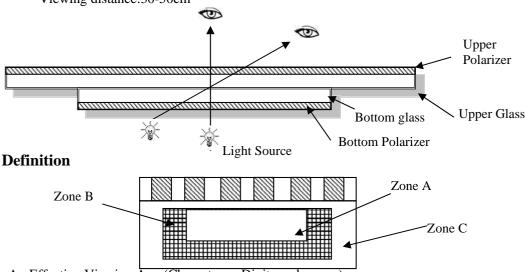
Inspection performed under the following conditions is recommended.

Temperature : 25 ± 5 °C Humidity : $65\%\pm10\%$ RH

Viewing Angle: Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



Zone A: Effective Viewing Area(Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A+Zone B) which can not be seen after assembly by customer.)

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer.

Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class $\,$ II AQL:

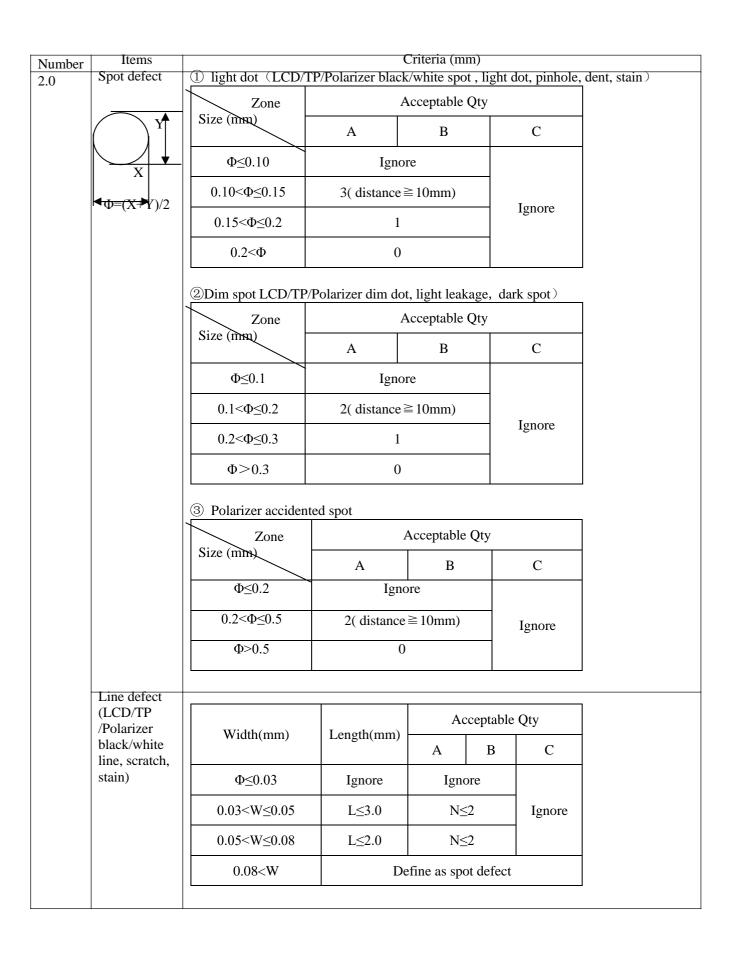
Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display, TP: Touch Panel, LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects	
1	Functional defects	 No display, Open or miss line Display abnormally, Short Backlight no lighting, abnormal lighting. TP no function 	Major	
2	Missing	Missing component		
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed		
4	Color tone Color unevenness, refer to limited sample			
5	Soldering appearance Good soldering, Peeling off is not allowed.		Minor	
6	LCD/Polarizer/TP Black/White spot/line, scratch, crack, etc.			

Criteria (Visual)

Criteria (Visu						
Number	Items	Criteria(mm)				
1.0 LCD Crack/Broken NOTE: X: Length	(1) The edge of LCD broken					
Y: Width Z: Height		X Y Z				
L: Length of ITO, T: Height of LCD		\leq 3.0mm $\stackrel{< \text{Inner border line of}}{\text{the seal}} \leq T$				
	(2)LCD corner broken	$\begin{array}{c cccc} X & Y & Z \\ \hline \leq 3.0 \text{mm} & \leq L & \leq T \end{array}$				
	(3) LCD crack	Crack Not allowed				



	Polarizer Bubble			A			
		Zone Size (mm)	A	Acceptable Qty A B			
3.0		Ф≤0.2	Ign	A B C			
3.0		0.2<Φ≤0.4 0.4<Φ≤0.6	(2(distance ≥ 10mm)		e	
		0.4<Ф <u>≤</u> 0.0 0.6<Ф		0			
4.0	SMT		C-A-610C class II st s are minor defect.	tandard . Functi	on defect a	and missing part are m	ajor
			Sizo (Mmm)	Acceptal		Qty	
		TP bubble/	Size Φ(mm)	A	В	С	
		accidented	Φ≤0.1 Ignore		e		
		spot	0.1<Φ≤0.2 0.2<Φ≤0.3	2		Ignore	
			0.2×Ψ <u><</u> 0.3 0.3<Φ	0			
		Assembly	beyond the edge of backlight ≤0.15mm				
		deflection					
5.0	TP Related		Newton Ring area> Newton Ring area≤				

	TP corner broken X : length Y: width Z: height	X X≤3.0mm * Circuitry br	Y Y≤3.0mm oken is not a	z z <lcd thickness</lcd 	Z	X	
	TP edge broken X: length Y: width Z: height	X X≤6.0mm * Circuitry b	Y Y≤2.0mm roken is not a	Z Z <lcd thickness allowed.</lcd 		z	
Criteria (functional items)	Criteria (functional items)						
Number	Number					Criteria (mm)	
1	1		No display			Not allowed	
2	Missing segment				Not allowed		
3	Short				Not allowed		
4		Backlight no lighting				Not allowed	

TP no function

Not allowed

RELIABILITY TEST

NO	ITEM	CONDTTION	STANDARD		
1	High Temp. Storage	80°C, 240 hours	1. Functional test is OK. Missing Segment, short,		
2	Low Temp. Storage	-30°C, 240 hours	unclear segment, non- display, display		
3	High Temp. Operation	70°C, 240 hours	abnormally and liquid		
4	Low Temp. Operation	-20°C, 240 hours	crystal leak are un- allowed.		
5	High temperature and high Humidity storage	40°C,90%RH, 240 hours	2. No low temperature bubbles, end seal loose		
6	Thermal and cold shock	Static state, -20°C (30 Min) ~70°C (30 Min) ~ -20°C (30Min), packaging, 10 cycles	and fall, frame rainbow.		
7	Vibration test	Packaging, Frequency: 10-55Hz Amplitude: 1.0mm, Each direction on X,Y axe 0.5 houre, circle 2 hours	1. Function test is OK. 2. No glass crack, chipped glass, end seal loose and fall, epoxy frame crack and so on.		
8	Dropping test	Pack products into the carton box. Drop it from 80cm height to ground. Once for each side of the carton	3. No structure loose and fall.		

NOTE:

The reliability items will be fully performed in new sample qualification,

The reliability status will be tested as monitor during mass production. Individual reliability test shall be performed by lot, Moreover, the individual reliability item shall be decided according to reliability plan.

All samples are inspected after keeping in the room with normal temperature and humidity for 2 hours or above.

Vibration test: It is not necessary to test for those products without assembly frame, back light, PCB and so on.

Dropping test: It is necessary for affirming new package.

For the high temperature and high humidity test, pure water of over 10 M Ω .cm should be used.

Each test item applies for test LCM only once .Then tested LCM cannot be used again in any other test item. The quantity of LCM examination for each test item is 5pcs to 10pcs.

Safety instructions

If the LCD panel breaks, be careful not to get any liquid crystal substance in your mouth.

If the liquid crystal substance touches your skin or clothes, please wash it off immediately by using soap and water.

Handling Precautions

Avoid static electricity damaging the LSI.

Do not remove the panel or frame from the module.

The polarizing plate of the display is very fragile. So, please handle it very carefully.

Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of the plate.

The color tone of display and background of LCM has the possibility to be changed in the storage temperature range.

Pay attention to the working environment, as the element may be destroyed by static electricity.

- --Be sure to ground human body and electric appliance during work.
- --Avoid working in a dry environment to minimize the generations of static electricity.
- --Static electricity may be generated when the protective film is fast peeled off.

When soldering the terminal of LCM, make certain the AC power source of soldering iron does not leak. If the display surface becomes contaminated ,breathe on the surface and gently wipe it with a soft-dry- clean cloth .If it is heavily contaminated ,moisten cloth with the following solvent(ex:Ethyl alcohol).Solvents other than those above-mentioned may damage the polarizer(Especially ,do not use them .ex: Warter / Ketone)

Operation instructions

It is recommended to drive the LCD within the specified voltage limits, try to adjust the operating voltage for the optimal contrast, the color and contrast of LCD panel will varies at different temperature.

Response time is greatly delayed at low operating temperature range. However, this does not mean the LCD will be out of the order, It will recover when it returns to the specified temperature range.

If the display area is pushed hard during operation, the display will become abnormal.

Do not operate the LCD at the environments over the specified conditions, this may cause damage on the LCD and shorten the lifetime.

Storage instructions:

Store LCDs in a sealed polyethylene bag.

Store LCDs in a dark place, Do not expose to sunlight or fluorescent light. Keep the temperature between 0° C and 35° C.

Avoid the polarizer touch any other object, (It is recommended to store them in the container in which they were shipped.)